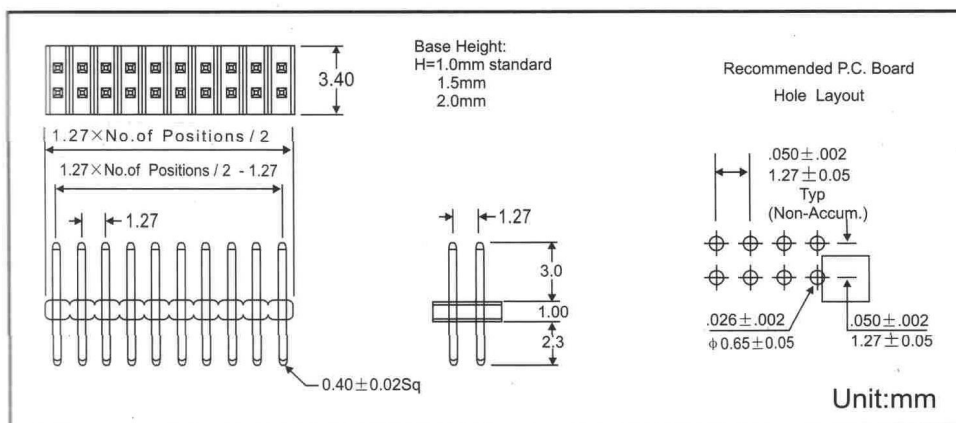
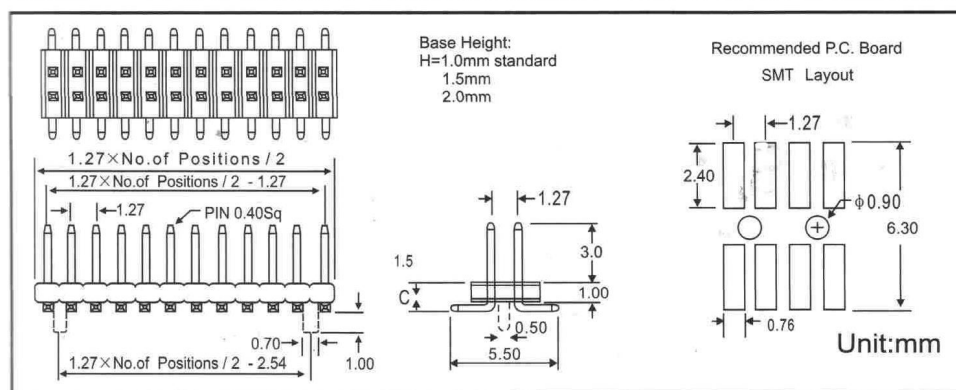


PIN HEADER STRIP DUAL ROW(1.27mm×1.27mm)

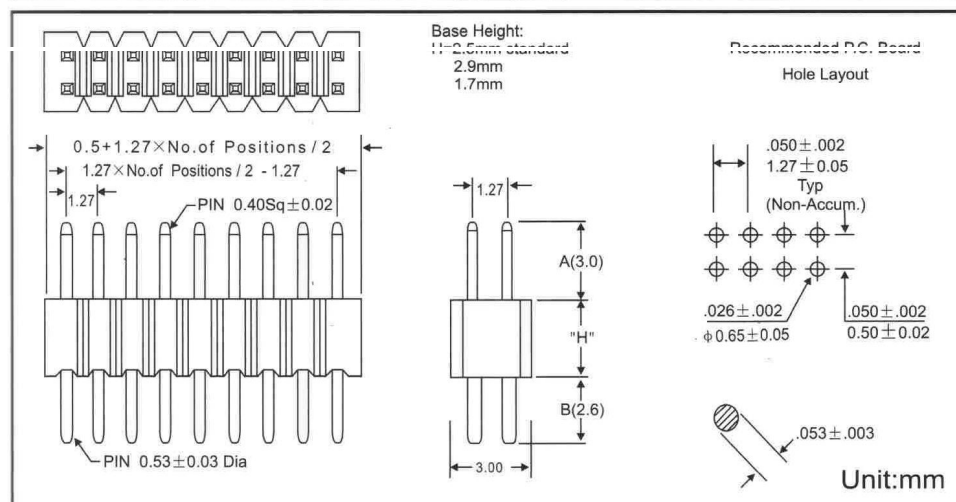
201-1/B Series



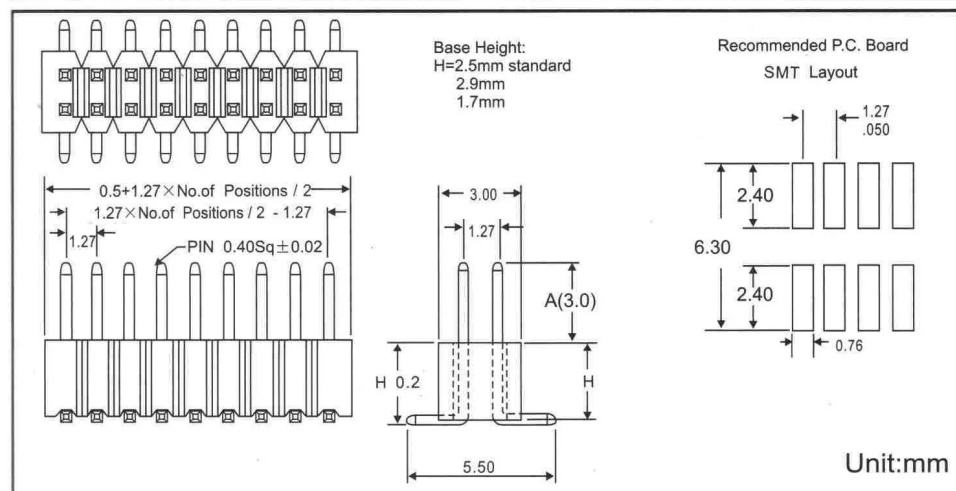
0.05 " x 0.05 " (1.27×1.27mm)
Pin Header Dual Row
06 to 100 Contacts
0.4mm Square Post
Low Profile:1.0mm
How to Order:
201-1/B-S-2×□P-3.1/1.0/2.3



0.05 " x 0.05 " (1.27×1.27mm)
Center SMT Pin Header
Dual Row 06 to 100 Contacts
0.4mm Square Post
Low Profile:1.0mm
How to Order:
201-1/B-SMT-2×□P- 3.1/1.0



0.05 " x 0.05 " (1.27×1.27mm)
Pin Header Dual Row
06 to 100 Contacts
0.4mm Square Post
How to Order:
201-1/B-S-2×□P- 3.1/2.5/2.6



0.05 " x 0.05 " (1.27×1.27mm)
Center SMT Pin Header
Dual Row 06 to 100 Contacts
0.4mm Square Post
How to Order:
201-1/B-SMT-2×□P- 3.0/2.5

Pitch:1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row Straight Dip Type

Technical Data

Material:

Contact Material: Brass

Insulator Material:Black Polyester UL94V-0

Standard:PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

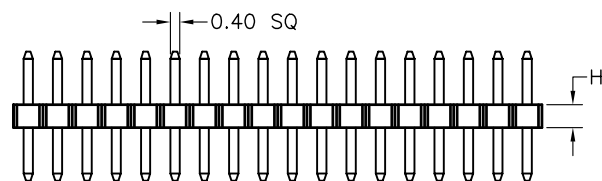
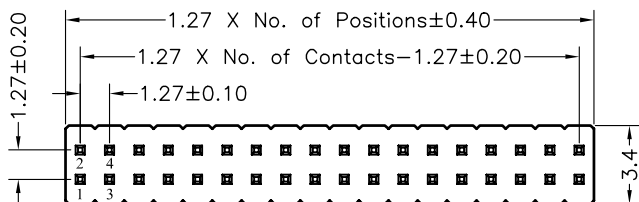
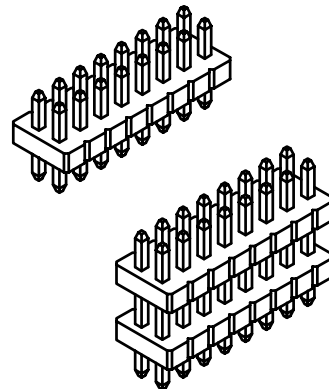
Withstanding Voltage:300V AC/minute

Mechanical:

Operating temperatures: Gold Plated:-55° C to +105° C

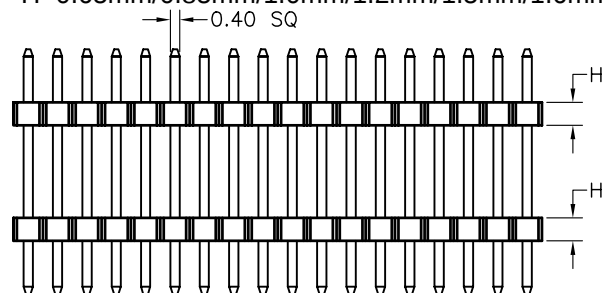
Tin plated:-40° C to +105° C

Soldering temperature: +260° C, 10s max.



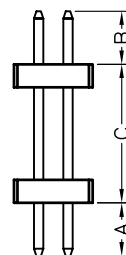
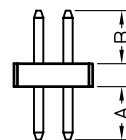
201-1/B-S-2*XXP (XX: NO. of Position Per Row 01 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm

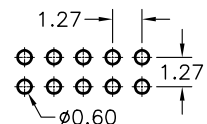


201-1DL/B-S-2*XXP (XX: NO. of Position Per Row 01 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm



Recommended
P.C.B Board
Hole Layout



Pitch:1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row Right Angle Dip Type

Technical Data

Material:

Contact Material: Brass

Insulator Material:Black Polyester UL94V-0

Standard:PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

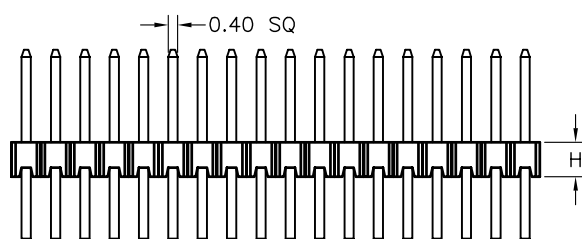
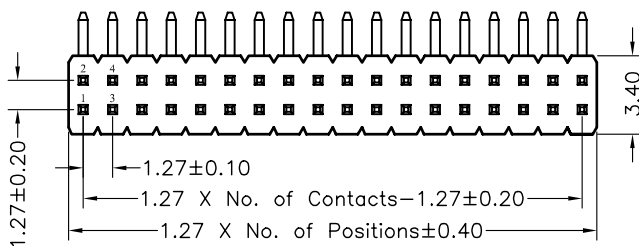
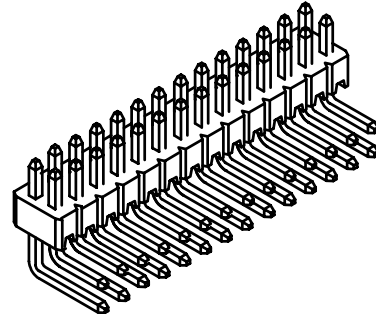
Withstanding Voltage:300V AC/minute

Mechanical:

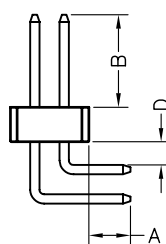
Operaing temperatures: Gold Plsted:-55° C to+105° C

Tin plated:-40° C to+105° C

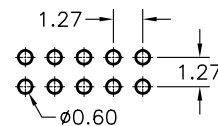
Soldering temperature: +260° C,10s max.



201-1/B-R-2*XXP (XX:NO. of Persition
Per Row 01 thru 50)
H=1.0mm/1.2mm/1.5mm



Recommended
P.C.B Board
Hole Layout



Pitch: 1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row Right Angle Dip Type

Technical Data

Material:

Contact Material: Brass

Insulator Material: Black Polyester UL94V-0

Standard: PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

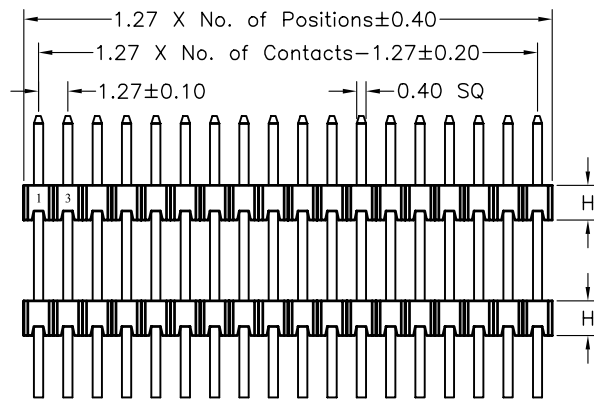
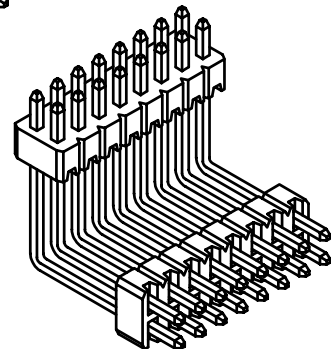
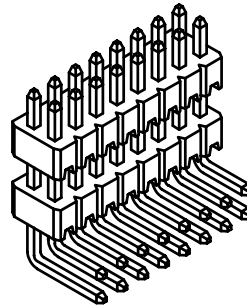
Withstanding Voltage: 300V AC/minute

Mechanical:

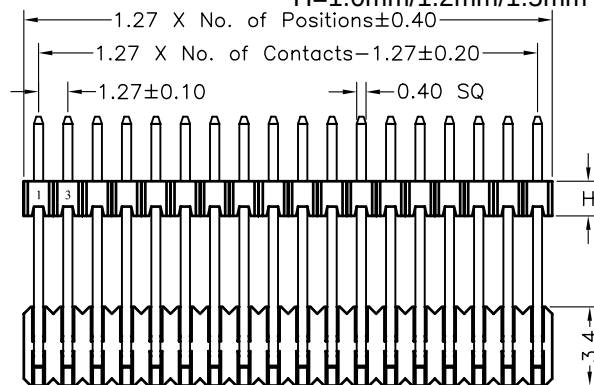
Operating temperatures: Gold Plated: -55°C to $+105^{\circ}\text{C}$

Tin plated: -40°C to $+105^{\circ}\text{C}$

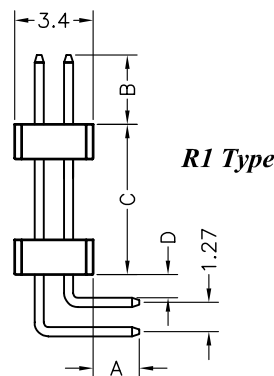
Soldering temperature: $+260^{\circ}\text{C}$, 10s max.



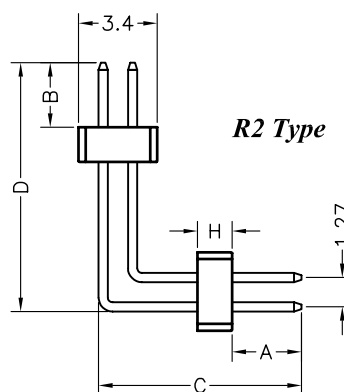
201-1DL/B-R/R1-2*XXP (XX: NO. of Persition Per Row 01 thru 50)
H=1.0mm/1.2mm/1.5mm



201-1DL/B-R/R2-2*XXP (XX: NO. of Persition Per Row 01 thru 50)
H=1.0mm/1.2mm/1.5mm

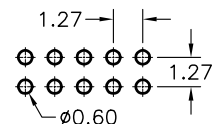


R1 Type



R2 Type

Recommended
P.C.B Board
Hole Layout



Pitch:1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row Right Angle Dip Type

Technical Data

Material:

Contact Material: Brass

Insulator Material:Black Polyester UL94V-0

Standard:PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

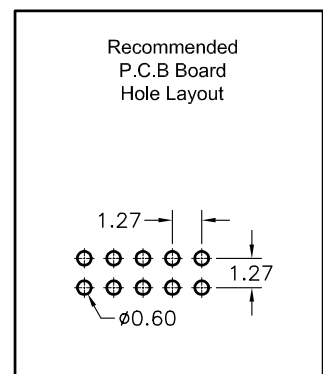
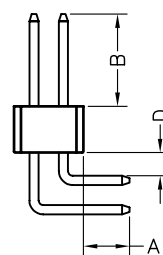
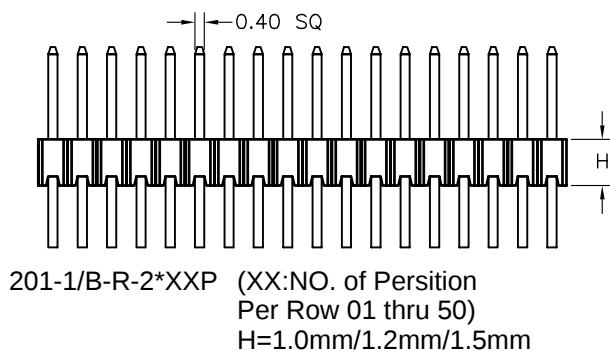
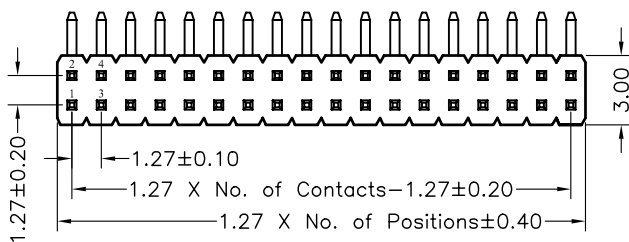
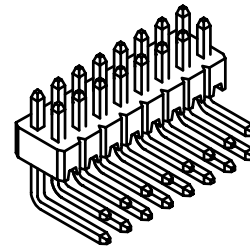
Withstanding Voltage:300V AC/minute

Mechanical:

Operating temperatures: Gold Plated:-55° C to+105° C

Tin plated:-40° C to+105° C

Soldering temperature: +260° C,10s max.



Pitch: 1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row Right Angle Dip Type

Technical Data

Material:

Contact Material: Brass

Insulator Material: Black Polyester UL94V-0

Standard: PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

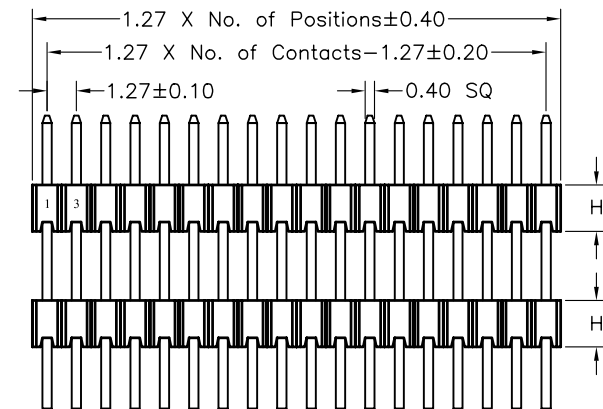
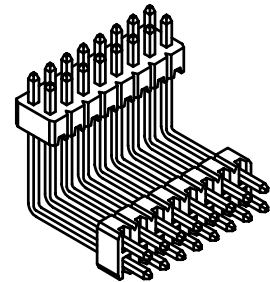
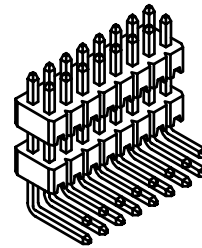
Withstanding Voltage: 300V AC/minute

Mechanical:

Operating temperatures: Gold Plated: -55°C to $+105^{\circ}\text{C}$

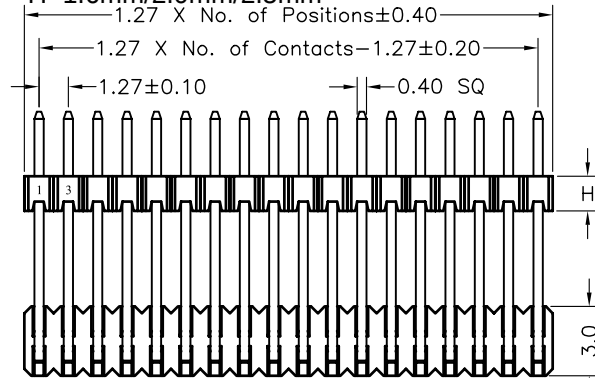
Tin plated: -40°C to $+105^{\circ}\text{C}$

Soldering temperature: $+260^{\circ}\text{C}$, 10s max.



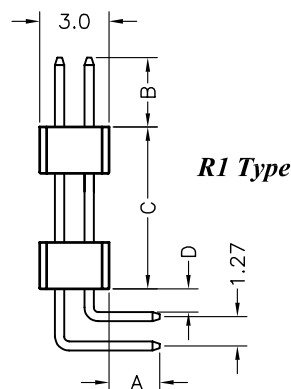
201-1DL/B-R/R1-2*XXP (XX: NO. of Persition Per Row 01 thru 50)

H=1.6mm/2.0mm/2.5mm

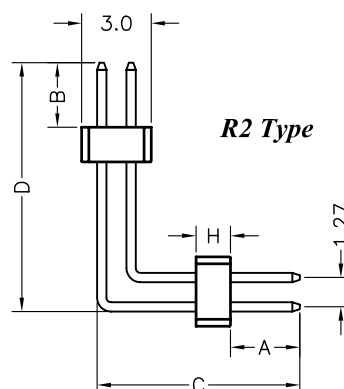


201-1DL/B-R/R2-2*XXP (XX: NO. of Persition Per Row 01 thru 50)

H=1.6mm/2.0mm/2.5mm

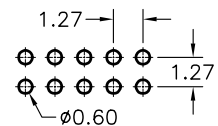


R1 Type



R2 Type

Recommended
P.C.B Board
Hole Layout



Pitch:1.27*1.27mm(0.05"*0.05") Pin Header Dual Row S.M.T Type

Technical Data

Material:

Contact Material: Brass

Insulator Material:Black Polyester UL94V-0

Standard:PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

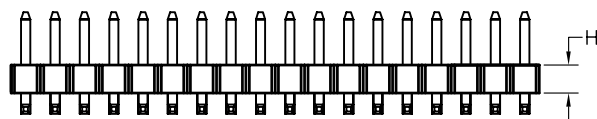
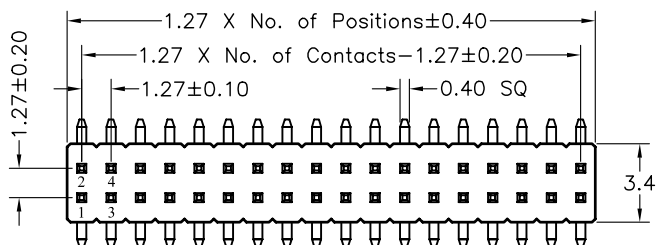
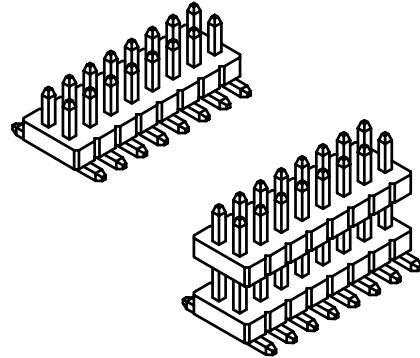
Withstanding Voltage:300V AC/minute

Mechanical:

Operaing temperatures: Gold Plsted:-55° C to+105° C

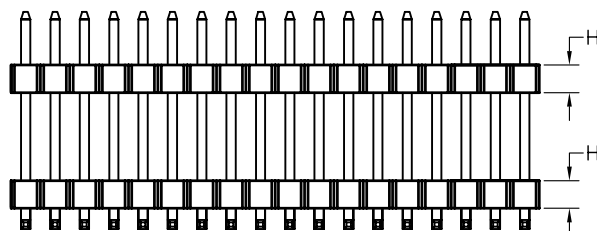
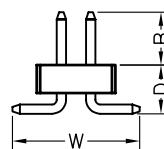
Tin plated:-40° C to+105° C

Soldering temperature: +260° C,10s max.



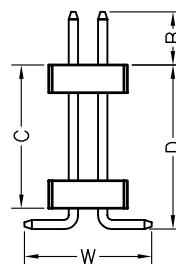
201-1/B-SMT-2*XXP (XX:NO. of Persition
Per Row 01 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm

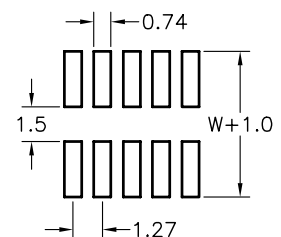


201-1DL/B-SMT-2*XXP (XX:NO. of Persition
Per Row 01 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm



Recommended
P.C.B Board
Layout



Pitch:1.27*1.27mm(0.05"*0.05")

Pin Header Dual Row With Post S.M.T Type

Technical Data

Material:

Contact Material: Brass

Insulator Material:Black Polyester UL94V-0

Standard:PA6T+30%G.F

Electrical:

Current rating: 1.0Amps/contact max.

Contact resistance: $\leq 20\text{m}\Omega/\text{contact}$

Insulation resistance: $\geq 1000\text{M}\Omega$ at $V=100\text{V}$

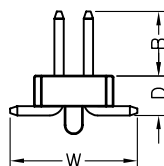
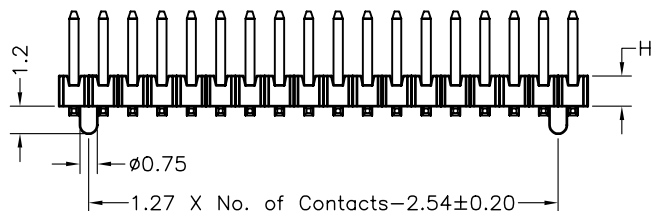
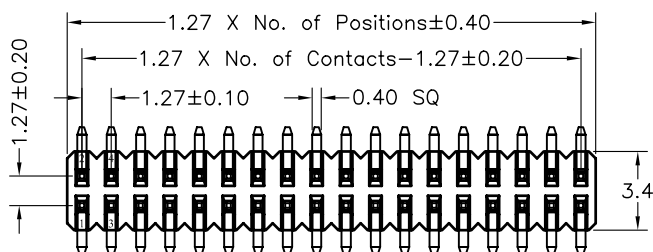
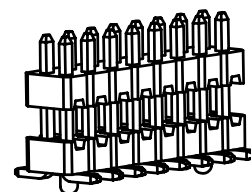
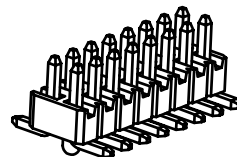
Withstanding Voltage:300V AC/minute

Mechanical:

Operating temperatures: Gold Plated:-55° C to +105° C

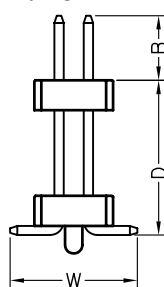
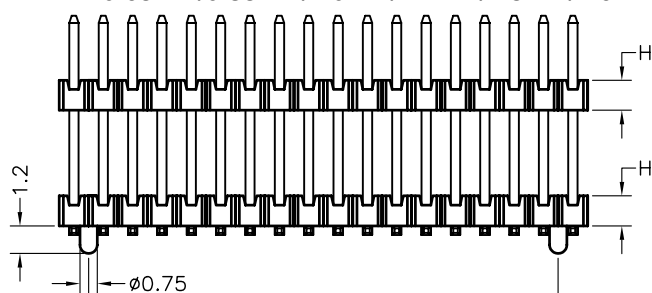
Tin plated:-40° C to +105° C

Soldering temperature: +260° C, 10s max.



201-1/B-SMT-2*XXP (With Location Column) (XX:NO. of Persition Per Row 03 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm



201-1DL/B-SMT-2*XXP (With Location Column)

(XX:NO. of Persition Per Row 03 thru 50)

H=0.65mm/0.85mm/1.0mm/1.2mm/1.5mm/1.6mm/2.0mm/2.5mm

